

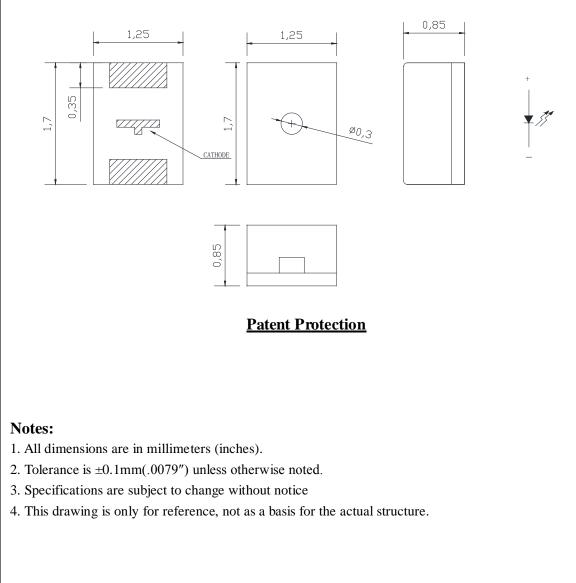
Features

- Low Power Consumption
- Various Colors
- Meet ROHS Green Product.

Applications

• Backlight and Indicator

Package Dimensions



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Selection Guide

Part No	Lens Type	Dice	Emitted Color
FDC-T085A-3T5NHPTCH	Black	AllnGap	Amber

Electrical / Optical Characteristics At Ta=25 °C

Symbol	Parameter	Min.	Тур.	Max.	Unit Test Condition	
Iv	Luminous Intensity(Note 1)	4.5	18	28	mcd	IF=5mA
入 Peak	Peak Emission Wavelength 611			nm	IF=5mA	
入d	Dominant Wavelength	600	605	609	nm	IF=5mA
$ ext{ } \Delta \lambda$	Spectral Line Half-Width		17		nm	IF=5mA
VF	Forward Voltage	1.7	1.9	2.3	V	IF=5mA
IR	Reverse Current			10	uA	VR 5V

Note:

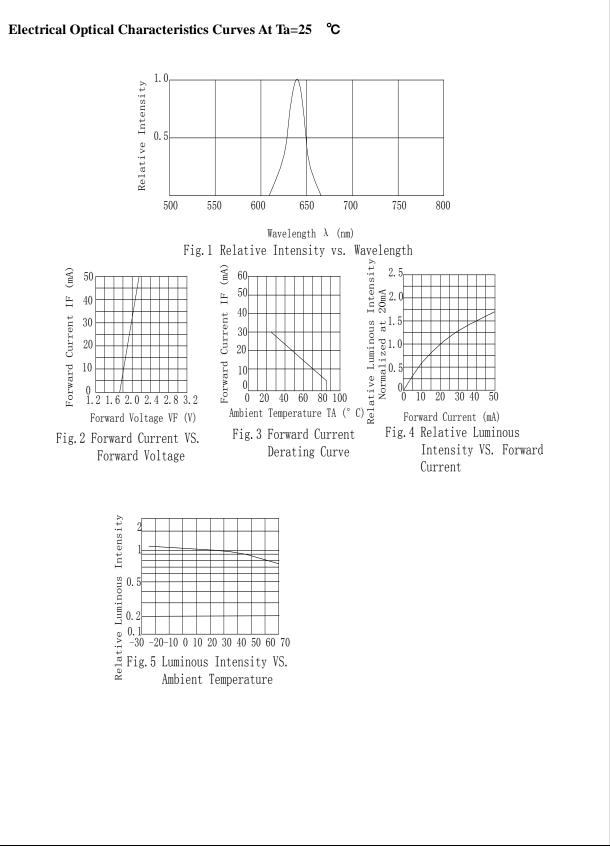
Absolute Maximum Ratings At Ta=25°C

Parameter	Amber	Unit	
Power Dissipation	75	mW	
Peak Forward Current[1]	80	mA	
Continuous Forward Current	30	mA	
Dreading Linear From25℃	0.4	mA/℃	
Reverse Voltage	5	V	
Electrostatic Discharge Threshold(HBM)	ectrostatic Discharge Threshold(HBM) 2000		
Operating Temperature Range	-55°C to + 85°C		
Storage Temperature Range	-55°C to + 85°C		
Soldering Condition	260°C For 5 Seconds		

Note:

1. 1/10DutyCycle, 0.1msPulseWidth







Bin Range Of Luminous Intensity

0					
Symbol	Bin Code	Min.	Max.	Unit	Condition
	J	4.5	7.2	mcd	IF=5mA
I	K	7.2	11.2		
Iv	L	11.2	18.0		
	М	18.0	28.0		

Bin Range Of Forward Voltage

Symbol	Bin Code	Min.	Max.	Unit	Condition
	V2	1.7	1.9	V	IF=5mA
VF	V3	1.9	2.1		
	V4	2.1	2.3		

Notes:

1. Tolerance of Luminous Intensity +/-20%

2. Tolerance of Forward Voltage +/-0.2V

3. Tolerance of the Dominate Wavelength +/- 2nm

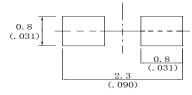
4. The Luminous Intensity is measured with the led excluded the black lens cover.



Process Note

- 1. Sells gives no other assurances regarding the ability of to withstand ESD. It is recommended to use a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.
- 2. Reflow soldering should not be done more than two times.
- 3. Do not stress LED when soldering, and do not warp the circuit board after soldering
- 4. While using Iron, Power dissipation of Iron should be smaller than 25W, and temperature should be controllable. The work should be finished within 2 sec under 320°C for once only.

Recommended Soldering Pad Dimensions



Notes:

- 1. The LEDs should be used within a year.
- 2. The LEDs should be kept in $5 \sim 30^{\circ}$ C and 60% RH for less.
- 3. The LEDs should be used within 24 hours, or else should be kept a 5~30°C and 30% RH or less. And LEDs should be used within 7 days after opening the package.



Reliability Test Items Conditions

FDC-T085A-3T5NHPTCH

Classification	Test Item	Test Conditions	Test hours	Result
Endurance Test	Operation Life	Connect with a power IF=5mA Ta=Under room temperature	1000Hrs	0/20
	High Temperature High Humidity	Ta=+65°C±5°C RH=90%-95%	240Hrs	0/20
	High Temperature Storage	High Ta=+85℃±5℃	1000Hrs	0/20
	Low Temperature Storage	Low Ta=-35°C±5°C Test time=1000hrs	1000Hrs	0/20
Environmental Test	Temperature Cycling	-45°C∼+105°C 15min 5min 15min	300 Cycles	0/20
	Thermal Shock	-35°C∼±5°C∼+85°C∼±5°C 5min 10sec 5min	300 Cycles	0/20
	Solder Resistance	Preheating: 120°C-150°C,within 2 minutes. Operation heating : 260°C (Max.),within5 seconds(Max.)	5Cycles	0/20

Judgment criteria of failure for the reliability

Measuring items	Symbol	Measuring conditions	Judgment criteria for failure
Forward voltage	VF(V)	IF=5mA	Over U×1.2
Reverse current	Ir(µA)	Vr=5V	Over U×2
Luminous intensity	Iv(mcd)	IF=5mA	Below S×0.5

Note: 1.U means the upper limit of specified characteristics. S means initial value.

2.Meansurment shall be taken between 2 hours after the test pieces have been returned to normal ambient conditions after completion of each test.